

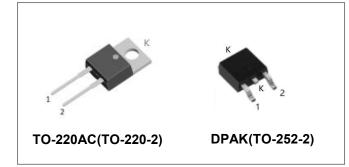
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**Technical Data** 

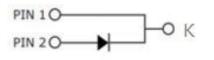
S4D02120A S4D02120E



# S4D02120A S4D02120E 1200V SIC POWER SCHOTTKY RECTIFIERS



#### **Circuit Diagram**



#### Applications

- Alternative energy inverters
- Power Factor Correction (PFC)
- Free-Wheeling diodes
- Switching supply output rectification
- Reverse polarity protection

#### **Maximum Ratings**

Maximum Natings					
Characteristics	Symbol	Condition	Max.	Units	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	-	1200	V	
Average Rectified Forward Current	I <sub>F (AV)</sub>	Tc=150°C	2	А	
Peak One Cycle Non-Repetitive Surge Current	I <sub>FSM</sub>	10ms, Half Sine pulse,  TJ =25°C	44	А	
Repetitive Peak Forward Surge Current	$\mathrm{I}_{FRM}$	10 ms, Half Sine pulse , $T_{\rm J}$ =25°C	13	А	

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#### Description

S4D02120A/S4D02120E are SiC Schottky rectifiers packaged in TO-220AC(TO-220-2)/DPAK(TO-252-2) case. The devices are high voltage Schottky rectifiers that have very low total conduction losses and very stable switching characteristics over temperature extremes. The S4D02120A/S4D02120E are ideal for energy sensitive, high frequency applications in challenging environments.

#### Features

- 175°C T<sub>J</sub> operation
- Ultra-low switching loss
- Switching speeds independent of operating temperature
- Low total conduction losses
- High forward surge current capability
- High package isolation voltage
- Terminals finish: 100% Pure Tin
- Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional electrical and life testing can be performed upon request



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#### **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units	
Forward Voltage Drop*	V <sub>F1</sub>	@ 2A, Pulse, T <sub>J</sub> = 25 °C	1.5	1.8	V	
	V <sub>F2</sub>	@ 2A, Pulse, T <sub>J</sub> = 175 °C	1.9	3.0	V	
Reverse Current*	I <sub>R1</sub>	@V <sub>R</sub> = rated V <sub>R</sub> T <sub>J</sub> = 25 °C	10	50	uA	
	I <sub>R2</sub>	$@V_R = rated V_R$ T <sub>J</sub> = 175 °C	40	150	uA	
Junction Capacitance	Ст	VR=0V, Tj=25℃,f=1MHz	116	-	pF	

Pulse width < 300 µs, duty cycle < 2%

## Thermal-Mechanical Specifications:

Characteristics	Symbol	S4D02120A	S4D02120E	Units
Junction Temperature	TJ	-55 to +175		°C
Storage Temperature	T <sub>stg</sub>	-55 to +175		°C
Maximum Thermal Resistance Junction to Case	$R_{qJC}$	1.7	1.5	°C/W

### **Ordering Information**

Device	Package	Shipping
S4D02120A	TO-220AC(TO-220-2)	50pcs / tube
S4D02120E	DPAK(TO-252-2)	2500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.



S4D02120A





S4D02120A S4D02120E

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**175℃** 

125°C

75°C

25°C

#### **Ratings and Characteristics Curves**

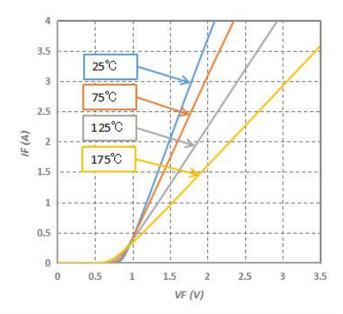


Fig.1-Typical Forward Voltage Characteristics

**Fig.2-Typical Reverse Characteristics** 

100 200 300 400 500 600 700 800 900 1000 1100 1200

VR (V)

1.0E-01

1.0E-02

1.0E-03

1.0E-04

1.0E-05

IR (uA)

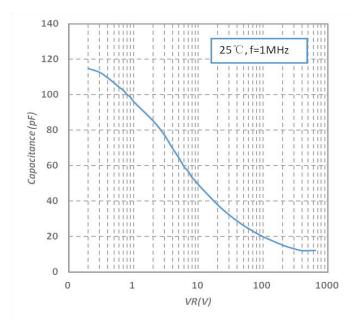


Fig.3-Capacitance vs. Reverse Voltage



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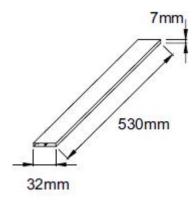
#### Marking Diagram



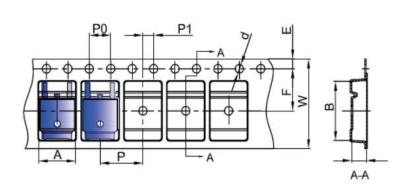


Where XXXXX is YYWWL S4D = Device Type = Package type = Forward Current (2A) A/E 02 \$4D02120E = Reverse Voltage (1200V) 120 S4D02120A SSG XXXXX SSG = SSG SSG XXXXXX YY = Year ww = Week = Lot Number L Cautions: Molding resin Epoxy resin UL:94V-0

## Tube Specification(TO-220-2)



## Carrier Tape & Reel Specification DPAK(TO-252-2)



SYMBOL	Millimeters			
STWBOL	Min.	Max.		
A	6.80	7.00		
В	10.40	10.60		
С	2.60	2.80		
d	Φ1.45	Φ1.65		
E	1.65	1.85		
F	7.40	7.60		
P0	3.90	4.10		
Р	7.90	8.10		
P1	1.90	2.10		
W	15.90	16.30		

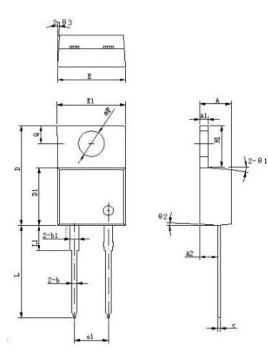


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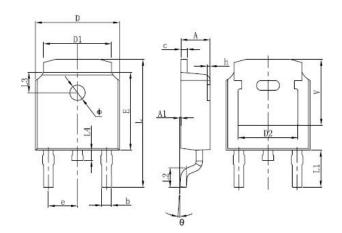
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#### Mechanical Dimensions TO-220AC(TO-220-2)



Symbol	Dimensions in millimeters			
Gymbol	Min. Typical		Max.	
A	4.55	4.70	4.85	
A1	1.17	1.27	1.37	
A2	2.59	2.69	2.89	
b	0.71	0.81	0.96	
b1		1.27		
с	0.36	0.38	0.61	
D	14.64	14.94	15.24	
D1	8.55	8.70	8.90	
E	10.01	10.16	10.31	
E1	9.98	10.18	10.38	
e1		5.08		
H1	6.04	6.24	6.44	
L	13.00	13.86	14.08	
L1		3.80		
ΦΡ	3.74	3.84	4.04	
Q	2.54	2.74	2.94	
Θ1		5°		
Θ2		4°		
Θ3		4°		

#### Mechanical Dimensions DPAK(TO-252-2)



	Millim	neters	Inches		
SYMBOL	Min.	Max.	Min.	Max.	
A	2.20	2.40	0.086	0.094	
A1	0	0.13	0	0.005	
b	0.635	0.889	0.025	0.035	
с	0.460	0.889	0.018	0.035	
D	6.50	6.70	0.250	0.265	
D1	4.95	5.46	0.195	0.215	
D2	4.32	REF.	0.170 REF.		
E	6.00	6.20	0.235	0.245	
е	2.286	BSC	0.090 BSC		
L	9.398	10.414	0.370	0.410	
L1	1.778 REF.		0.108 REF.		
L2	1.40	1.78	0.055	0.07	
L3	1.60 REF.		0.063 REF.		
L4	0.60	1.02	0.024	0.040	
Φ	1.10	1.30	0.043	0.051	
Θ	0°	10°	0°	10°	
h	0	0.30	0	0.012	
V	5.21 REF.		0.205	REF.	



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